

# LE SYLVANIA

Electronic Components Group Circuit Module Operation P.O. Box 360 Muncy, Penna. 17756 717 546-3191

SUB./DATE: MATTEL/SYLVANIA MEETING 11/1/78 REVIEW OF OUTSTANDING TECHNICAL MATTERS

November 1, 1978

TO: Attendees:

Mattel Dave Chandler Cliff Perry

Sylvania (CMO) Tom Gouldy Rusk Smith Bob Asplund Joe Hunt Howard Sprankle Granny Derr Dave McGuire Leo Buries John Bellotti Vance Larka

- 1. Mattel will change "Cassette" to "Cartridge".
- 2. Item 37 (Washer, Push-on) cannot define. Dave thinks it is a duplication. He will investigate and advise 11/2/78.
- 3. RF Shields Mattel will not be able to define until after FCC testing. Logic Bd will have to be enclosed with connectors outside. FCC Consultant states that shields will have to be soldered to Board, Mattel feels they can be clipped on and are pushing for a clip arrangement. Shield will be metal. Dave will provide shield definition ASAP-preliminary shield definition by 11/15. Shields for 10 FCC units will be provided to G.I. by Mattel. Shields for 40 units will be provided by Mattel to CMO. There is a possibility that cartridges will have to be shielded. Mattel will assign part numbers for shields immediately.
- Mattel will investigate if they will assign part number on paint and advise either a number or if we are to assign.
- G.I. had advised the need for ferrite beads on the controller wires (1 per wire on each end). Dave does not think this is necessary and will check with G.I. on Thursday. CMO will be advised 11/2/78 p.m. by phone.
- Cable assembly must have ferrite beads on each end. Mattel will breakdown parts list for antenna cable assy.
- Controller will have flat circuitry with a special piece of bubbled mylar added (Domed Ledgend Overlay) which will be added to parts list.
- Mattel will assign part numbers for ferrite beads on controller P/L item 46.
- 9. Parts list item 64 will be changed to radial.
- 10. Item 63 15/16" is the maximum height that can be allowed on any component on the power supply board.

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- 11. Item 72 Heatsink we have Thermalloy part 6071B should be 6072B?
- 12. Item 73 Rivet We will only need 1 instead of 2. (Regulator will dissipate 4 watts)
- 13. Drawing #39-159 was provided by Mattel (Pwr. Supply P.C. Layout) also the logic Bd. P.C. Layout #39-157 and cartridge board P.C. Layout Dwg. #39-158.
- 14. Dave will investigate with G.I. the need for 10 to 20 turn pots and advise 11/2/78.
- 15. Dave will define the TBD values for resistors (Items 88 thru 92) with GI and advise 11/2/78 those that can be pinned down at this time.
- 16. Item 96 CMO can give either Axial leads or radial leads. CMO prefers axial. Item 97 - CMO can give either Axial leads or radial leads. CMO prefers axial.
- 17. Item 93 and 95 was an assumption on CMO's part. Dave will check out with G.I. and advise 11/2/78.
- 18. CMO will use GI part numbers for Chips on master parts list.
- 19. Item 114 Crystal should be  $\pm$ .001%- CMO will assign part number.
- 20. Item 110 Different conditions received with EMM quotes. CMO will provide info today to Dave to have clarified with GI on Thurs. Dave will advise CMO 11/2/78.
- 21. Item 115 CMO will assign part number.
- 22. Item 116 GI will spec.
- 23. Item 117 & 118 CMO will assign part number.
- 24. Item 119 Mattel part number 2609 9399 is applicable.
- 25. Item 120 Ferrite Beads Dave expects to resolve need at GI on Thurs. and will advise CMO 11/2/78.
- 26. Item 121 thru 125 CMO will specify.
- 27. Master parts list, in a similar format as used in 11/1/78 meeting at CMO, to be issued by Mattel by 11/9/78 for use as a master to be used by Mattel, G.I. and Sylvania.

#### 28. Chip testing

Current CMO pricing based on 0.65% AQL acceptance level at incoming test with full sets being returned to G.I. when failures are found. Dave will discuss with G.I. if the return of full sets will be required after first couple thousand units.

Mattel will get commitment from G.I. on the process average they are willing to provide on matched sets and CMO will evaluate and advise

impact to Mattel.

Dave will get definition from G.I. as to what their 1% process average per component is and phone Vance Larka/Joe Hunt with info on 11/2/78.

Dave will review with G.I. relative to any documentation that can be provided to CMO on chips so as to enable us to develop our test equipment.

- 29. Dave will discuss with G.I. and advise us their best date to provide CMO with both bare boards and completed assemblies to enable CMO to develop test equipment CMO need is 12/1/78.
- 30. Bob Asplund will join Dave Chandler and Cliff Perry at G.I. on 11/2/78 to obtain latest schematic and parts list on Logic Board. Sylvania will run a parallel program with G.I. in Logic Board circuit layout and manufacturing of initial Logic P.C. Boards.
- 31. Discussion was held relative to the problem of the time remaining between now and January for material procurement. Dave advised that the parts list which Mattel will release 11/9 will be the latest and should be used for start of procurement activities. Dave further advised that CMO should evaluate and if there are some long lead items that CMO cannot wait for the 11/9 P/L, CMO should advise Mattel and get advance authorization.
- 32. Cliff Perry will correlate P/L provided by Sylvania 11/1 and the documentation responsibility listing developed at Mattel during the Mattel/Sylvania/G.I. meeting of 9/27/78 and establish completion dates for outstanding items. Completion date for outstanding items 11/9/78.
- Trimmer cap. for frequency adjust must be adjustable from bottom. R. Asplund to confirm component used.
- 34. CMO assumes they will participate at G.I. in the testing of the 40 prototypes. Dave will discuss with G.I. and advise CMO 11/2/78.
- 35. Mattel will supply hand controller assembly sets and the plastic console housings to G.I. for 10 prototype units.

36. The system burn-in specification included in Item 27 of the minutes of the 9/27/78 meeting as set forth below was completed by recommending that one person per shift be assigned to be continually testing the systems from the first (2) weeks of production during the specified burn-in periods. This will provide more frequent data during the initial hours and less frequent during later hours. The systems are to be burned-in at room temperature. No T.V. is needed for each set during burn-in, but the cartridge must be plugged in during burn-in. Note that the assumption is that, during the rest of production, an 8-hour burn-in will be required.

Sylvania should be prepared to activate such a burn-in program.

250 unit pilot run - Burn-in 168 hrs.

50 per day 1st week - 250 units - Burn-in 168 hrs.

75 per day 2nd week - 375 units - Burn-in 48 hrs.

125 per day 3rd week - 625 units - Burn-in 8 hrs.

All follow-on production - Burn-in 8 hrs.

NOTE: Where item number is used - reference is to item number on attached parts list.

JOHN R. ROBERTSON

2609-9993 STANDARD PACK (1978)

SUGGESTED SOURCE																		Shakeproof Hi-Lo	Shakeproof Hi-Lo	Midwest	
PART DESCRIPTION		Master Carton	Tape - 3" Reinforced	Toy in Individual Labelled Carton	Individual Carton - Labelled	Individual Carton .	Label	Tape - 2" Clear	End Cap → Styrofoam Bead	Tape - 1" Clear	Polyethylene Sleeve (11½" x 24")	Instruction Sheet	Football Cassette	Video Game	Console Assembly	Console Base	Tray	Screw, 8-18x1"	Screw, 8-18x½"	Transformer Assembly	
UNIT	MEAS.	Ea.	A/R	Ea.	Ea.	Ea.	Ea.	A/R	Ea.	A/R	Ea.	Ea.	Ea.	Ea.	Ea.	Ea.	Ea.	Ea.	Ea.	Ea.	
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NUMBER REQUIRED FOR NEXT ASSEMBLY	5 6 7		4/R A				_	N/R	2												
DWG. FOR NEXT ASSEMBLY	1 2 3 4 5 6 7	B 1				B 1	A 1	A VR	D 2		A 1				ш						
NUMBER FOR NEXT	SIZE 1 2 3 4 5 6 7		4/R							VR		2609-0920	2610-9991	2609-9991 1 E	2609-9109 1 E	2609-2109	2609-2149				

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SOURCE TED SOURCE	SOURCES LED SOURCE	Amp #640428-5 Molex KK .156" Series	Shakeproof Hi-Lo			Wilmington Fiber, Synthane-Taylor	3M #SJ-5012						-	Shakeproof Hi-Lo			Palmut #PD 156007			
DABT DESCRIPTION	FARI DESCRIPTION	Connector, 5 Pin - For Transformer	Screw, 6-19x½"	Shield, R. F. Upper	Shield, R. F. Lower	Insulator, 3" x 4" Fish Paper	Adhesive Foot, .14" Thk. x .5" Dia., Polyurethane	Console Cover - Labelled	Label - Plain	Label - Controls	Console Cover - Painted	Paint	Console Cover	Screw, 8-18x3/4"	Button - Reset	Spring - for Reset Button	Pushnut Fastener	Glamour Cap	Washer, Push-on	
TINO	MEAS.	Ea.	Ea.	Ea.	Ea.	Ea.	Ea.	Ea.	Ea.	Ea.	Ea.	A/R	Ea.	Ea.	Ea.	Ea.	Ea.	Ea.	Ea.	
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	26	2609-9993 STANDA	STANDARD PACK	CK (	(1978)		Con	(Continued)	(pai				
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wZ	ш>	NUMBER	SIZE	-	2	3 6	4 3	3 6		8	MEAS.	PART DESCRIPTION	SUGGESTED SOUNCE
8		2609-9599									Ea.	Antenna Cable Assembly	Astec; Columbia Electronic Cables
68		2609-9609									Ea.	Antenna Switch Assembly	Astec
0:		2611-0340					_				Ea.	Label - Serial Number	
=		2609-9059					2				Ea.	Hand Controller Assembly	
12		2609-9579						_			Ea.	Controller Cable Assembly w/Connectors	
13	100 may 11 mg 151	2609-9569							_		Ea.	Cable, 9 Wire, Coiled	Victor
14		2609-9469							_		Ea.	Connector - Controller, 9 Pin	Circuit Assembly Corp.
15		2609-9479							_		Ea.	Connector - Console, 10 Pin, Card Edge Molex	Molex
91		1							6 .		Ea.	Ferrite Bead; .20" ID, .38" 0D, .19" L	Fair-Rite #263000801
17		2609-2059	ш								Ea.	Housing, Lower	
18		2609-9589						_			Ea.	Circuit Matrix	Chomerics
19		2609-2099	J					2			Ea.	Push Buttons	
20		2609-9089						_			Ea.	Disc - Control W/Inlay	
12		2609-2089	8						_		Ea.	Disc - Control	
52		2609-0310							_		Ea.	Inlay	
53		5609-9069									Ea.	Housing - Upper Subassembly	
54		2609-2069	Ы						_		Ea.	Housing - Upper	
22		2609-2079	O O						_		Ea.	Frame	

2609-9993 (Continued)

7	2609-9993 (Continued)	inued)										
E1	PART	DWG.	26	N N	NUMBER FOR NEXT	REGASS	REQUIRED	ED	7	TINI	NOTE DESCRIPTION	POSICE TED SOURCE
۳> دیر	NUMBER	SIZE	-	3	4	80	9	-	8	MEAS.	TAKE DESCRIPTION	70000
9	0405-0842						4			Ea.	Screw, 5-20 x 7/16"	Shakeproof Hi-Lo
7	0405-4279						_			Ea.	Compression Spring	
8	2609-9539					_				Ea.	Power Supply Board Assembly Per G.I. Parts List #39-147 Rev. B	
6	1						_			Ea.	IC1 - 7805C Positive Voltage Regulator, 5V ± 5%, TO-220 Package	Signetics, TI, National, Fairchild, Motorola, NEC
0	1						_			Ea.	IC2 - 7812C Positive Voltage Regulator, 12V ± 5%, TO-220 Package	Signetics, TI, National, Fairchild, Motorola, NEC
-	1						8			Ea.	D1-D8: IN4001, Rectifier, 1 Amp, 50V	61, 177
2	1						_			Ea.	D9 - IN746A, Zener, 3.3V, 5%, 500 mW	NPC, Motorola, Siemens, Fairchild, NEC
3	1						-			Ea.	C1 - Aluminum Cap., 10,000 uF, -10+100%, 16V, Axial	United Chemi-Con #16TAL1000 Nichicon, Elna, Illinois Ca
4	1									Ea.	C2 - Aluminum Cap., 100 uF, -10+100%, 5V, Axial	United Chemi-Con #25TAL100, Elna, Nichicon, Illinois Ca
2	1						3			Ea.	C4,5,6 - Ceramic Cap., 0.1 uF, 20%, 15V, Z5U, Radial	Centralab Type 2DDU, Erie Transcap, Dilectron Type RT Murata, KCK
9							_			Ea.	R1 - Carbon Film, 220 0hm, 5%, 날씨	Airco, R-Ohm, ICC
2	1						_			Ea.	C3 - Aluminum Cap., 1000 uF, -10+100%, 25V, Axial	United Chemi-con #35.TAL1000 Elna, Nichicon #35TAL1000, Illinois Cap.
8	1						_			Ea.	Power Switch, 3PST Slide	UID #SW432-SD-LO-S-B1-JK
6	1						6			Ft.	Wire, 22 AWG, 7/30 Stranded	American Electric Cable, Teledyne Thermatics

2609-9993 (Continued)

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	SUGGESTED SOURCE	Amp #640383-5, Molex KK.156" Series	Amp #640383-6 Molex KK.156" Series	Thermalloy #6071B	Keystone			Airco, R-Ohm, ICC						>	Airco, R-Ohm, ICC	
	PART DESCRIPTION	Connector, P/C Header, 5 Pin, to Transformer	Connector, P/C Header, 6 Pin to Logic Board	Heatsink for TO-220 Package	Rivet	P/C Board, NEMA Grade CEM-1, .062" Thk Single-sided, 12.2 Sq. In., Bare Copper Circuit	Logic Board Assembly per G.I. Parts List #39-147 Rev. B	R1, 5 - Resistor, Carbon Film, 1K Ohm, Airco, 5%, 4W	R2 - Res., Carbon Film, 47 Ohm, 5%,4W	R4 - Res., Carbon Film, 300 Ohm, 5%, 4W	R7,8 - Res., Carbon Film, 3.3K Ohm, 5%, ¼W	R9 - Res., Carbon Film, 560 Ohm, 5%, 4W	RIO - Res., Carbon Film, 10K Ohm, 5%, 14W	Rll - Rês., Carbon Film, 100 Ohm, 5%, 4W	R13,14,23 - Res., Carbon Film, 10 Ohm, Airco, R-Ohm, ICC 5%, 14W	
TIME	OF MEAS.	Ea.	Ea.	Ea.	Ea.	Ea.	Ea.	Ea.	Ea.	Ea.	Ea.	Ea.	Ea.	Ea.	Ea.	
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TO COLOR	SUGGESTED SUUNCE	Airco, R-Ohm, ICC					>	Airco, R-Ohm, ICC	,Piher PT 15YD, Stackpole, CTS	Piher PT 15YD, Stackpole, CTS	Centralab Type 200T, Erie Type 801, Dilectron, Murata, KCK	Centralab Type 2DDU, Erie Transcap, Dilectron Type RT Murata, KCK	
MOLTAIGOSTA TARA	PART DESCRIPTION	R16 - Res., Carbon Film, 470 Ohm, 5%, ¼W	R17 - Res., Carbon Film, 2.2K Ohm, 5%, 4W	R18 - Res., Carbon Film, 200K Ohm, 5%, 4W	R30 - Res., Carbon Film, 150 Ohm, 5%, ¼W	R3,6,15 - Res., Carbon Film, TBD, 5%, 4W	R19,20,21 - Res., Carbon Film, TBD, 5%, 4W	R22,26,27 - Res., Carbon Film, TBD, 5%, 4W	R24,25,28 - Potentiometer, Carbon, TBU, Piher PT 15YD, Stackpole, 20%, ¼W @ 55°C, 270° Rotation, P/C Mount, .65" Dia., Open Construction	R29 - Potentiometer, Carbon, TBD, 20%, %W @55 C, 270 Rotation, P/C Mount, .65" Dia., Open Construction	C1 ← Ceramic Cap., 20pF, 5%, 15V, NPO, Radial	C4-22,24 - Ceramic Cap., 0.luF, 20%, 15V, Z5U, Radial	
TINO	MEAS.	Ea.	Ea.	Ea,	Ea.	Ea.	Ea.	Ea.	Ea.	Ea.	Ea.	Ea.	
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4>	NUMBER	SIZE	-	2	33	4	2	6 7	8	MEAS.		
	1							_		Ea.	C25 - Ceramic Cap., 100pF, 5%, 15V, NPO, Radial	Centralab Type 2DDT, Erie Type 841, Dilectron, Murata KCK
	1							2		Ea.	C3,26 - Aluminum Cap., luf, -10+100%, 15V, Axial	United Chemi-con 16TAL100, Illinois Capacitor, Elna, Nichicon
	1							3		Ea.	C27,28,30 - Solid Tantalum Cap., 10uF, 20%, 35V, Radial	Sprague 199D, Kemet T392D, Elna, ITT, NEC
	1							_		Ea.	C31 - Ceramic Cap., .01uF, 20%, 15V, Z5U, Radial	Centralab Type 2DDU, Erie Transcap, Dilectron Type RT, Murata, KCK
	1									Ea.	D1 - Rectifier, IN4001, 1 Amp, 50V	61, 177
	1							2		Ea.	Q1,2 - 2N3906, PNP Small Transistor	Fairchild, National, ITT, NPC, NEC
	1									Ea.	Q3 - 2N39O4, NPN Small Signal Trans.	Fairchild, National, ITT, NPC, NEC
	ı							_		Ea.	IC1 - CP1610, uP	
	ı							_		Ea.	IC2 - RA-3-9600, RAM	19
	i							_		Ea.	IC3 - RO-3-9504, 2KX10 ROM	61
	1							_		Ea.	IC4 - AY-3-9600, STIC	19
	ı							_		Ea.	IC5 - RO-3-9503, 16K ROM	19
	ı							_		Ea.	IC6 - AY-3-8910, PSG	19
	1							_		Ea.	IC9 - R0-3-9502, 2KX10 ROM	19
	1							_		Ea.	IC10 - AY-3-8915, Color	19

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2	T	-	-	NON	ABER	RR	0	REQUIRED	1	=	LIN		
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	1							3			Ea.	IC7, 8, 12 - 256x8 RAM	EMM-Semi 3539 UCP
	ľ							_			Ea.	IC11 - 7406, Hex Inverter	Fairchild, National, TI, Signetics, NEC
	1										Ea.	IC13 - 74LSO8, Quad and Gate	Fairchild, National, TI, Signetics, Motorola
	ı							2			Ea.	IC14,15 - 74LS126, Quad Buffer	Fairchild, National, TI, Signetics, Motorola
	1										Ea.	XTL - Crystal, 3.579545 MHZ, + .01%	Erie, Electro-Dynamics Reeves-Hoffman, Q-Matic
	1							_			Ea.	C2 - Trimmer Cap., 5.1-50pF, Ceramic, .35" Dia., P/C Mount	Matsushita #ECY-1ZW50X321H Sprague-Goodman #6KD50000
	1							-			Ea.	RFX - Modulator	Astec #UM1285
	1										Ea.	SI - SPST Switch	CTS Dwg. C1690A
	1							-			Ea.	S2 - SPDT Slide Switch, P/C Mount	UID #SL-012-SD-T0-P-B1-EK-CE
	1							-			Ea.	Connector, P/C Card Edge, 44 Pin	Methode
	1							9			Ea.	Ferrite Bead, .20" ID, .38" 0D, .19"L	Fair-Rite #263000801
	i							9			Ea.	IC Socket, 40 Pin DIP	T.I. #C8540-01, Augat, Cambi
	1							_			Ea.	IC Socket, 18 Pin DIP	T.I. #C8518-01, Augat, Cambio
	1							_			Ea.	IC Socket, 28 Pin DIP	T.I. #C8528-01, Augat,Cambio
	1							_			Ea.	Connector, 6 Pin - To P/S Board	Amp #640428-6 Molex KK.156" Series
	ı							.5			Ft.	Wire, 22 AWG, 7/30 Stranded	American Electric Cable, Teledyne Thermatics
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PART DESCRIPTION		P/C Board, NEMA Grade CEM-1, .062" Thk., Double-sided, PTH, 48.8 Sq. In Solder Mask One Side, Solder Plated Copper Circuit						
UNIT	MEAS.	Ea.						
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ED	7							
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# MATTEL VIDEO GAME SYSTEM

#### PARTS LIST

#### LOGIC BOARD:

DESIGNATION	P/N	DESCRIPTION	SOURCE
IC7, IC8, IC12 IC11 Q1,Q2 D1 R1,R5 R2 R3,R6,R15 R19,R20,R21 R22,R26,R27 R4 R7,R8 R9 R10 R11 R13,R14,R23 R16 R17 R18 R24,R25,R28	3539 7406 2N3906 IN4001 IK 47~ TBD TBD TBD 300~ 3.3K 560~ 10K 100~ 10 ~ 470~ 2.2K 200K TBD	256 X 8 RAM  Hex Inverter  Transistor  Diode  ¼ W Resistor "  ¼ Trim Potentiometer	EMM-Semi
R29 XTAL RFX C1 C2 C4-C22,C24 C25 C26,C3 C27,C28,C30 C31 S1 S2	3.579MHz Um1285 20 pf 5-50 pf .1 uF 100 pf 1 uf 10 uf .01 uf SPST-C1690A SPDT	Crystal Modulator Capacitor Trim cap Cap. Cap. Cap. Cap. Switch Switch SL-021-SD-TO-P-B1-EK-	Astec  CTS of Elkhart
P7 P4a P4b J3 IC 13 IC 14, IC 15 Q3 R30 I.C. Sockets	Edge Fingers or AMP 640099-9 640428-2 74LS08 74LS126 2N3904 150 <b>Ω</b>	Connector Connector Connector Quad. and Gate Quad. Tri-state buffe Transistor W Resistor For I.C.1, I.C.2,I.C. I.C.6,I.C.7,I.C.8,I.C I.C.12	AMP AMP r 3,I.C.4,I.C.5,

### MATTEL VIDEO GAME SYSTEM

#### Parts List (con't)

#### POWER SUPPLY BOARD:

DESIGNATION	P/N	DESCRIPTION	SOURCE
S3 IC1 IC2 D1-D8 D9 C1 C2 C4,C5,C6	SW432-SD-LO-S-B uA 7805 uA 7812 IN4001 IN746A 10000 uf 100 uf .1 uf	1-JK Switch 5V regulator 12V regulator Diode 3.3V Zener Diode 16V Cap. 5V Cap. Cap.	UID/AMF Nichicon
R1 C3 P2 P3	220 <b>~</b> 1000 uf 640383 - 5 640383 - 6	25V Cap. Connector Connector	AMP AMP

#### TRANSFORMER ASSY:

J2 640428-5 Connector AMP

HAND CONTROLLER: (2 per system)

J4 10 Pin Edge or Connector AMP AMP 640-443-9

FAN ASSY:

J7 J8 Connector

Note: Mattel will supply

information a.s.a.p.

ANTENNA CABLE

ANTENNA SWITCH

#### MATTEL VIDEO GAME SYSTEM

Parts List (con't)

#### CONSOLE ASSEMBLY

P/N	DESCRIPTION
0405-0802	Screw (8-18 X 1") Shakeproof Hi-Lo
0405-0822	Screw (6-19 X 1/2") Shakeproof Hi-Lo
2609-9489	Foot - Adhesive 3M SJ-5112
0405-0832	Screw (8-18 X 3/4") Shakeproof Hi-Lo

## HAND CONTROLLER ASSEMBLY

0405-0842 Screw (5-20 X 7/16") Shakeproof Hi-Lo

Suggested T.C. Assembly Layout Guides

These guides are suggested for assemblies containing axial lead components to be automatically prepped, sequenced and machine inserted with present available tooling and equipment at the Sylvania, Muncy facility only.

For GTE Sylvania use only.

Rev



SYLVANIA ELECTRONIC COMPONENTS GROUP



Title

P.C. ASS'Y. LAYOUT GUIDE AXIAL LEAD COMPONENTS INSERTION MACHINES MUNCY, PA. Dwg. No. 1261

Sheet 1 of

# Insertion Machine Capacity

- 1. Max. insertable area 12" X & 12" Y.
- 2. Uninsertable areas Components cannot be inserted within .375 R from any hole that is used for locating P.C. board to machine table. Components leads must be no closer than .180 from P.C. board edges. See Figure 1. Locating holes should always be close to board edge as possible (2 are required).
- 3. Can insert on lead centers from .250 min. to 1.250 max.
- 4. Min., Max. insertable component size.

	Body Dia.		· · · · · · · · · · · · · · · · · · ·	min.	1.000	max.
	Body Length	Copper		min.	.046	max.
c.	Lead Dia.	Steel	.010	min.		max.
		Covar	.010	min.	.030	max.

- 5. All axial lead components and bare wire that fall within the above size range, are lead taped and meet lead tape Spec. No. A-1234 can be machine inserted.
- 6. Present sequencer capacity Components with physical size range between \(\frac{1}{4}\) W RC07 resistor and \(\frac{1}{2}\) W RC-20 resistors can be sequenced and retaped to be inserted on a maximum of .700 lead centers.
- 7. Components with similar physical size but different components (or different values or the same component) that number five or less per type, per assembly, are generally sequenced prior to insertion.

INSERTABLE AREA

P.C. BOARD

P.C. BOARD HOLDER

ON MACHINE

15

SYLVANIA ELECTRONIC COMPONENTS GROUP

For

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Title P.C. ASSEMBLY LAYOUT
GUIDE
AXIAL LEAD COMPONENTS
INSERTION MACHINES MUNCY, PA.

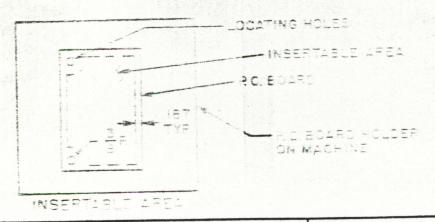
Dwg. No A-1261

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Re

If possible, the following ground rules should be followed:

- 1. Hole Size
- Componence common te incommed within . tratimo P.C.
- a. Finished hole size to be .020 to .025 dia. over component lead dia. - ecu
- 2. All axial lead components should be mounted in same axis, same lead centers and have same hole size. Mever more than two axis mounting and as few different lead centers and hole sizes as possible. min.
  - 3. All like components should always be on same lead centers. I.E. & W resistors, .500 centers; & W resistors, .700 centers, etc.
- 4. Components that are similar in physical size should be layed cut on same lead centers and same hole size. Calculate lead centers and hole size using largest component I.E. DO 7 case diodes, 1 W resistors would be on .500 lead centers and hole size would be from .045 to .050 diameter. The same would a-apply for & W resistors and some sizes of capacitors etc., and 1 W resistors and some sizes of capacitors, etc. Dwesser Secrence.
- 5. -- Component Folarization de sequence: and recaded og de inserved on a maximum of .700 lea? Diodes - Cathode end should be in same direction for all.
  - b. Capacitors + end should be in same direction for all.
- 6. Always use maximum component size when calculating lead centers rand clearances. These rules are to be used as guides and not torestrictions. Components can be inserted into smaller holes, etc.
- 7. Lagout axial lead components on .025, .050, or .100 grid. .050 and .100 preferred.
- In special cases where these guides and rules are not applicable, each case must be considered separately and usually leads to redesign of insertion tooling and increased tooling costs and turn around time.



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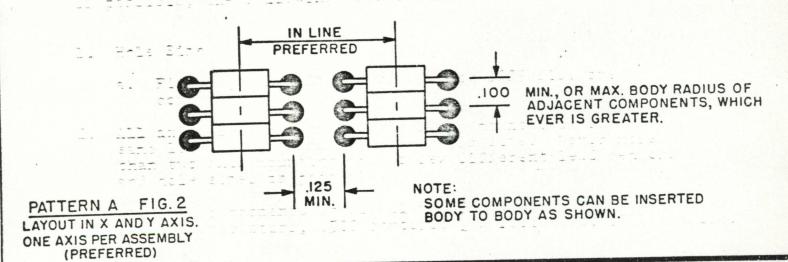
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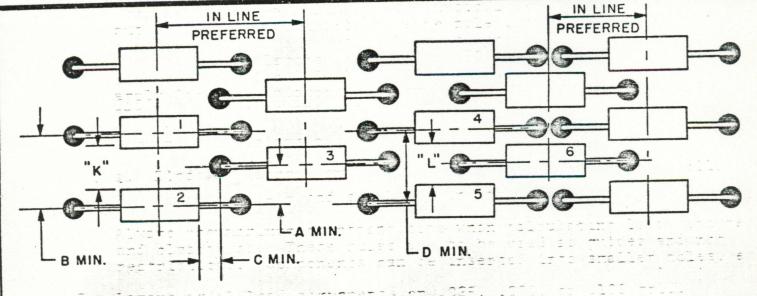
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# COMPONENT & TOOL CLEARANCE, AND SOME SUGGESTED LAYOUT PATTERNS





PATTERN B FIG. 3

PATTERN C FIG. 4
-LEAD & BODY INTERLACED

ONE AXIS PREFERRED

A MIN. = .070 + 1/2 WIRE DIAMETER OF COMPONENT NO. 2.

B MIN. = .140 + 1/2 WIRE DIAMETER OF COMPONENTS NO. 1 & 2 OR 1/2 MAX. BODY DIAMETER OF COMPONENTS 1 & 2, WHICH EVER IS GREATER.

C MIN. = .100 (IF "K" IS OVER .140 - .100 MIN. NOT REQ'D)

D MIN. = .140 + 1/2 MAX. BODY DIAMETER OF COMPONENTS 4 8 5 ("L" DIMENSION MUST BE .140 MIN.)

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050 OFF UPWARD TO NEAREST WIRE DIA. CHART. ROUND TR'S = MAX. A + 2X FROM LEAD TYPES, DIODES, RESISTORS, CAPS, ETC. WITH PRESENT AVAILABLE TOOLING & EQUIPMENT AT MUNCY. COMPONENT LEAD CENTERS, ALL AXIAL AXIAL LEAD COMPONENT SIZE ( PREFERRED MIN. & MAX. LEAD CENTERS FOR AUTOMATIC INSERTION) LEAD CLINCH BELOW RES. RES. RES. RES. 1/4 W DIODE DO-7 CASE SIZE RES. 1/8 W \* CENTERS MIN., HOWEVER DUE TO INSUFFICIENT INSERTION TIME IS HIGHER THAN NORMAL 2 × \_ ≼ P.C. BOARD STYLE RCO7 STYLE RC20 STYLE RC05 STYLE RC42 STYLE RC32 COMP \_\_ .250 MIN. — 1.250 MAX. AT. P.C. .648 SEE .344 TIGHT CLINCH .53 3 2 219 230 .130 BOARD TYPEI BEFORE SOLDER WIRE DIA. MIN. .688 562 .375 .250 .265 NOM .145 020 OVER MAX RCO7 RESISTORS, AND DO7 CASE DIODES CAN BE INSERTED IN .400 CLEARANCE IN INSIDE FORMERS. COMPONENT SCHRINKAGE AND 728 .593 .300 416 281 .160 -WIRE DIA .300 .085 210 .082 .058 N Z - 5 .075 MIN.-.100 PREFERRED TYPE 2 (PREFERRED) .318 .225 .090 .096 .062 NOM. 138 B LOOSE CLINCH WIRE DIA. .336 .161 .098 .107 .066 MAX WIRE DIA .240 .040 .020 .015 .050 .030 .025  $015 \pm 003 | 300, 500, 700$ 020±.002 0451.003 .040±.005 .031 ±.005 025±.002 LEAD DIA. ♣ 15° TO 80° TO HOLD CHAR . 1 5 .050 .120 .090 .085 .075 X Z COMPONENT IN BOARD P.C. BOARD .500,.700 .500,.700 1.000 .900 PREF. .700 LEAD COMPONENT FALLS BE-WHEN WIRE DIAMETER OF HIGHER WIRE DIAMETER TO OBTAIN "X" MIN. TWEEN WIRE SIZES LISTED IN CHART, USE NEXT CENTERS .250 1.000 .800 .600 .450 .450 1.250 1.250 1.250 1.250 1.250 .250 MAX. No. Dwg. SYLVANIA ELECTRONIC COMPONENTS Title A-1261 LAYOUT GUIDE COMPONENTS P.C. AXIAL C ASS'Y LEAD 25 5 of Sheet MACHINES MUNCY GROUP

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